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Vishay/Siliconix SI7601DN-T1-GE3

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Datasheet of SI7601DN-T1-GE3 - MOSFET P-CH 20V 16A 1212-8

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Si7601DN

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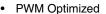
P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)	
- 20	0.019 at V _{GS} = - 4.5 V	- 16 ^e	16.2 nC	
	0.031 at V _{GS} = - 2.5 V	- 16 ^e	10.2110	

FEATURES

- Halogen-free Option Available
- TrenchFET[®] Power MOSFET
- Low Thermal Resistance PowerPAK[®]
 Package with Small Size and Low 1.07 mm

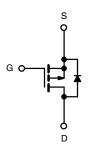
 Profile



100 % R_a and UIS Tested

APPLICATIONS

- DC/DC Buck Converter
- · High-Side Application for Asynchronous Buck



P-Channel MOSFET

3.30 mm 3.30 mm 2 3.4 Bottom View

PowerPAK 1212-8

Ordering Information: Si7601DN-T1-E3 (Lead (Pb)-free) Si7601DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 20	V		
Gate-Source Voltage		V _{GS}	± 12	V	
	T _C = 25 °C		- 16 ^e		
Continuous Proin Current /T 150 °C)	T _C = 70 °C		- 16 ^e		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	l _D	- 11.5 ^{a, b}		
	T _A = 70 °C		- 9.2 ^{a, b}	Α .	
Pulsed Drain Current		I _{DM}	- 40	^	
Continuous Course Drain Diada Current	T _C = 25 °C		- 16 ^e		
Continuous Source-Drain Diode Current	T _A = 25 °C	ls =	- 3.15 ^{a, b}		
Avalanche Current	L = 0.1 mH	I _{AS}	15		
Single-Pulse Avalanche Energy		E _{AS}	11.25	mJ	
	T _C = 25 °C		52		
Maniana Dania Distribution	T _C = 70 °C	В	33		
Maximum Power Dissipation	T _A = 25 °C	P _D	3.8 ^{a, b}	W	
	T _A = 70 °C		2.4 ^{a, b}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 50 to 150		
Soldering Recommendations (Peak Temperature) ^{c, d}			260	°C	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. See Solder Profile (http://www.vishay.com/doc?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- e. Package limited.

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THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R _{thJA}	26	33	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.9	2.4		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
 b. Maximum under Steady State conditins is 81 °C/W.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A		- 16.8			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		2.63		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	- 0.6		- 1.6	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	1	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	μΑ	
	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 55 °C			- 10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 40			Α	
	D.	V _{GS} = - 4.5 V, I _D = - 11 A		0.016	0.0192	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 8.9 A		0.025	0.0313		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 11 A		31.7		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1870		pF	
Output Capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		490			
Reverse Transfer Capacitance	C _{rss}			460			
Total Gate Charge	Q _g	V _{DS} = - 10 V, V _{GS} = - 5 V, I _D = - 11 A		18	18 27		
Total Gate Charge				16.2	25	nC	
Gate-Source Charge		$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -11 \text{ A}$		4.1		l IIC	
Gate-Drain Charge	Q_{gd}			4.8			
Gate Resistance	R _g	f = 1 MHz		6.1	9.2	Ω	
Turn-On Delay Time	t _{d(on)}			18	27		
Rise Time				112	168	no	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -9.2 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		53	80	ns	
Fall Time	t _f			80	120	1	
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 16		
Pulse Diode Forward Current ^a	I _{SM}				- 40	A	
Body Diode Voltage	V _{SD}	I _S = - 6 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			42	63	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	l _F = - 5 A, dl/dt = 100 A/μs, T _{.l} = 25 °C		25.2	38	nC	
Reverse Recovery Fall Time	t _a	- 1F = - 5 A, αι/αι = 100 A/μs, 1 _J = 25 °C		14		ns	
Reverse Recovery Rise Time	t _b			28			

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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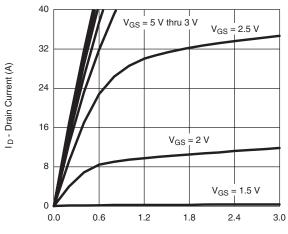
New Product



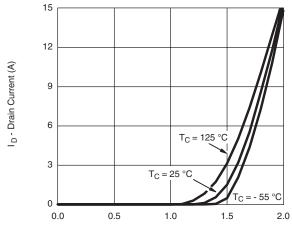
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

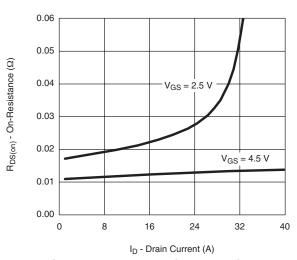


V_{DS} - Drain-to-Source Voltage (V)

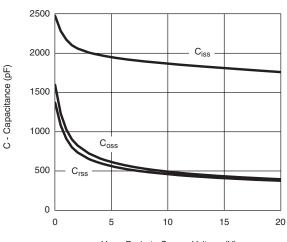


V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**

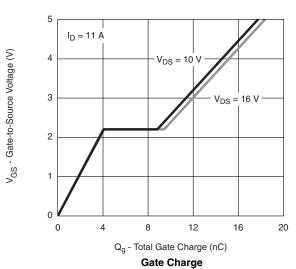
Output Characteristics



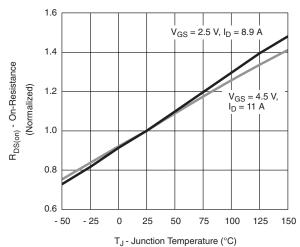
On-Resistance vs. Drain Current and Gate Voltage



 $V_{\mbox{\footnotesize DS}}$ - Drain-to-Source Voltage (V)



Capacitance



On-Resistance vs. Junction Temperature

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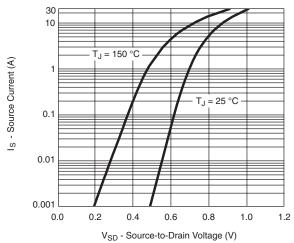
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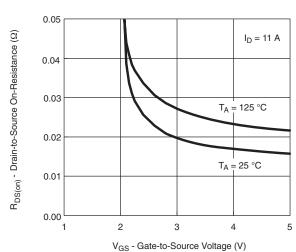
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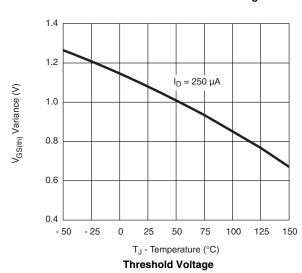
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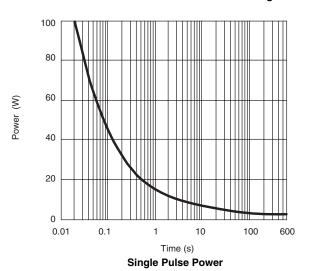


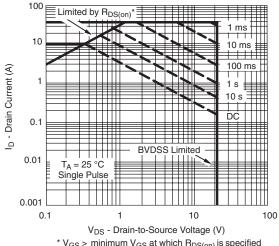
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage







* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



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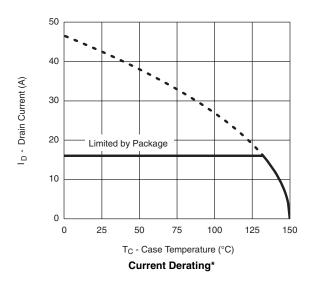
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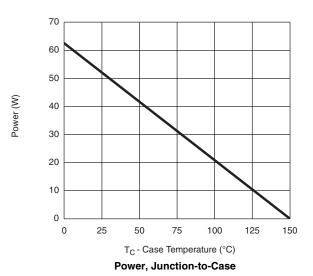


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 $^{^{\}star}$ The power dissipation P_D is based on T_{J(max)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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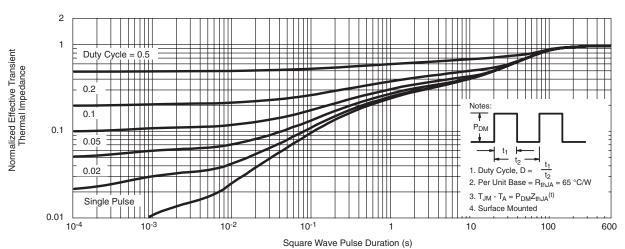
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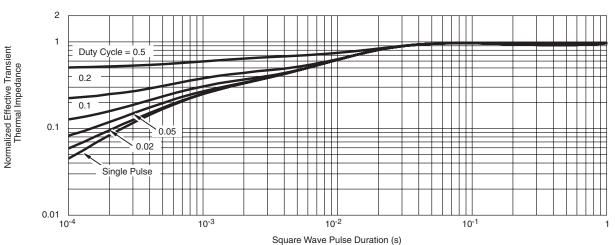
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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